

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JUI-YU PAN	12/06/2016
CHENG-BO SHU	12/08/2016
CHUNG-JEN HUANG	12/06/2016
JING-RU LIN	12/06/2016
TSUNG-YU YANG	12/06/2016
YUN-CHI WU	12/06/2016
YUEH-CHIEH CHU	12/27/2016
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Property Type	Number
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PATENT

DATE SIGNED:	12/12/2022
Total Attachments: 9 source=Assignment#page1.tif source=Assignment#page2.tif source=Assignment#page3.tif source=Assignment#page4.tif source=Assignment#page5.tif source=Assignment#page6.tif source=Assignment#page7.tif source=Assignment#page8.tif source=Assignment#page9.tif	

PATENT ASSIGNMENT

PARTIES TO THE ASSIGNMENT

Assignor(s):

Jui-Yu Pan

Assignor(s):

Cheng-Bo Shu

Assignor(s):

Chung-Jen Huang

Assignor(s):

Jing-Ru Lin

Assignor(s):

Tsung-Yu Yang

Assignor(s):

Yun-Chi Wu

Assignor(s):

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Assignee:

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Republic of China

AGREEMENT

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled
"METHOD TO FABRICATE UNIFORM TUNNELING DIELECTRIC OF EMBEDDED
FLASH MEMORY CELL" for which:

a non-provisional application for United States Letters Patent:

☒ was executed on even date preparatory to filing (each inventor should sign this
Assignment on the same day as he/she signs the Declaration); or

☐ was filed on _____ and accorded U.S. Serial No. _____; or

☐ I hereby authorize and request my attorney associated with Customer No. 107476, to insert on the designated lines below the filing date and application number of said application when known:

U.S. Serial No. _____,

filed on _____.

WHEREAS, ASSIGNEE (listed above), a corporation of the Republic of China is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE its successors and assigns, the entire right, title and interest in and to said invention and improvements, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, re-examinations and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents required for the making and prosecution of applications for

TSMC Docket No. P20151270US00
Docket No. TSMCP709USA

United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

2016/12/06
Date

Jui-Yu Pan
Name 1st Inventor Jui-Yu Pan

TSMC Docket No. P20151270US00
Docket No. TSMCP709USA

2016/12/08
Date

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Name 2nd Inventor Cheng-Bo Shu

TSMC Docket No. P20151270US00
Docket No. TSMCP709USA

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Chung-Jen Huang
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TSMC Docket No. P20151270US00
Docket No. TSMCP709USA

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Jing-Ru Lin
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Yun-Chi Wu

Name 6th Inventor Yun-Chi Wu

TSMC Docket No. P20151270US00
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Date

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Name 7th Inventor Yueh-Chieh Chu